SLDS011B - OCTOBER 1985 - REVISED MAY 1993

- Drives up to 20 Lines
- 70-V Output Voltage Swing Capability
- 40-mA Output Source Current Capability
- High-Speed Serially-Shifted Data Input
- CMOS-Compatible Inputs
- Direct Replacement for Sprague UCN5812A

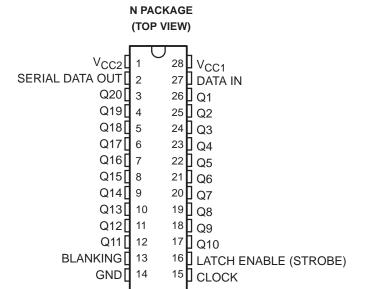
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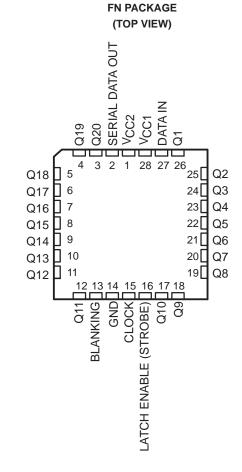
The TL5812 and TL5812I are monolithic BIDFET† integrated circuits designed to drive a dot matrix or segmented vacuum fluorescent display (VFD). Each device features a serial data output to cascade additional devices for large display arrays.

A 20-bit data word is serially loaded into the shift register on the low-to-high transition of CLOCK. Parallel data is transferred to the output buffers through a 20-bit D-type latch while LATCH ENABLE is high and is latched when LATCH ENABLE is low. When BLANKING is high, all outputs are low.

The outputs are totem-pole structures formed by npn emitter-follower and double-diffused MOS (DMOS) transistors with output voltage ratings of 70 V and a source-current capability of 40 mA. All inputs are CMOS compatible.

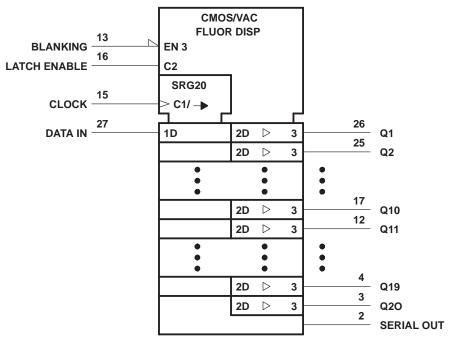
The TL5812 is characterized for operation from 0° C to 70° C. The TL5812I is characterized for operation from -40° C to 85° C.





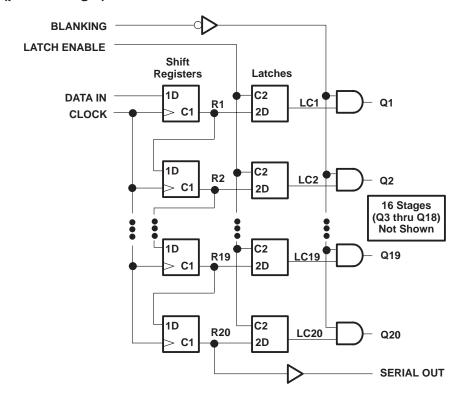
†BIDFET - Bipolar, double-diffused, N-channel and P-channel MOS transistors on same chip. This is a patented process.

logic symbol[†]



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)





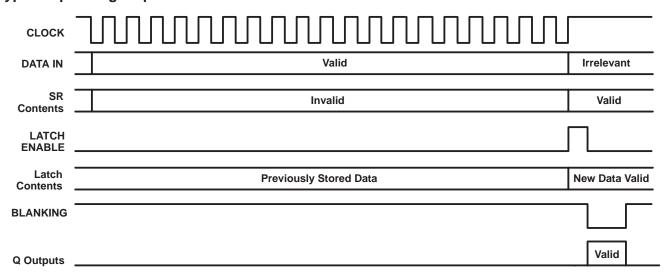
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FUNCTION TABLE

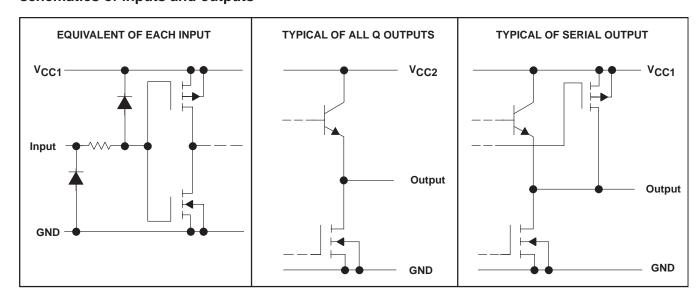
	(CONTROL IN	IPUTS	SHIFT REGISTERS	T DECISTEDS ATOUES		OUTPUTS			
FUNCTION	СГОСК	LATCH ENABLE	BLANKING	R1 THRU R20	LATCHES LC1 THRU LC20	SERIAL	Q1 THRU Q20			
Load	↑ No↑	X X	X X	Load and shift [†] No change	Determined by LATCH ENABLE‡	R20 R20	Determined by BLANKING			
Latch	X X	L H	X X	As determined above	Stored data New data	R20 R20	Determined by BLANKING			
Blank	X X	X	H L	As determined above	Determined by LATCH ENABLE‡	R20 R20	All L LC1 thru LC10, respectively			

H = high level, L = low level, X = irrelevant, $\uparrow = low-to-high-level transition$.

typical operating sequence



schematics of inputs and outputs



[†] R20 takes on the state of R19, R19 takes on the state of R18, ... R2 takes on the state of R1, and R1 takes on the state of the data input.

[‡] New data enter the latches while LATCH ENABLE is high. These data are stored while LATCH ENABLE is low.

TL5812, TL5812I VACUUM FLUORESCENT DISPLAY DRIVERS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC1} (see Note 1)		15 V
Supply voltage, V _{CC2}		70 V
Output voltage, VO		70 V
Input voltage range, V _I		\dots -0.3 V to V _{CC1} +0.3 V
Output current, IO		40 mA
Continuous total power dissipation		. See Dissipation Rating Table
Operating free-air temperature range:	TL5812	0°C to 70°C
	TL5812I	40°C to 85°C
Storage temperature range,		65°C to 150°C
Case temperature for 10 seconds: FN	package	260°C
Lead temperature 1,6 mm (1/16 inch) f	from case for 10 seconds: N package	260°C

NOTE 1: All voltage values are with respect to GND.

DISSIPATION RATING TABLE

PACKAGE	T _A ≤ 25°C POWER RATING	DERATING FACTOR ABOVE T _A = 25°C	T _A = 70°C POWER RATING	T _A = 85°C POWER RATING
FN	1400 mW	11.2 mW/°C	896 mW	728 mW
N	1150 mW	9.2 mW/°C	736 mW	598 mW

recommended operating conditions

		MIN	NOM MAX	UNIT
Supply voltage, V _{CC1}	4.5	15	V	
Supply voltage, V _{CC2}		0	60	V
High-level input voltage, VIH		V _{CC1} -1.5	V _{CC1} +0.3	V
Low-level input voltage, V _{IL}		-0.3†	0.8	V
High-level output current, IOH			-40	mV
Operating free air temperature Ta	TL5812	0	70	°C
Operating free-air temperature, TA	TL5812I	-40	85	C

[†] The algebraic convention, in which the less positive (more negative) limit is designated as minimum, is used in this data sheet for logic voltage levels.



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electrical characteristics over operating free-air temperature range, V_{DD} = 5 V to 15 V, V_{BB} = 60 V (unless otherwise noted)

	PARAMETER			CONDITIONS	MIN	TYP [‡]	MAX	UNIT	
		Q outputs	$I_{OH} = -25 \text{ mA}$		57.5	58.2			
Vон	High-level output	OFDIAL DATA OUT	V _{CC1} = 5 V,	$I_{OH} = -20 \mu A$	4.5	4.9		V	
		SERIAL DATA OUT	$V_{CC1} = 15 \text{ V},$	$I_{OH} = -20 \mu A$	14.5	14.9			
		Q outputs	$I_{OL} = 1 \text{ mA},$	BLANKING at V _{CC1}		0.7	1.5	V	
VOL	Low-level output voltage	SERIAL DATA OUT	V _{CC1} = 5 V,	I _{OL} = 20 μA		0.06	0.3		
			$V_{CC1} = 15 \text{ V},$	I _{OL} = 20 μA		0.03	0.3		
lн	High-level input current		$V_I = V_{CC1}$			0.3	1	μΑ	
I _I L	Low-level input current	Low-level input current				-0.3	-1	μΑ	
lOL	Low-level output current (pulldown current)		$V_0 = 60 V$,	BLANKING at V _{CC1}	2.5	3.2		μΑ	
IO(off)	Off-state output current	Off-state output current		BLANKING at V _{CC1}		< - 1	-15	μΑ	
	Supply current from V _{CC2}		Outputs high			3.5	8	4	
ICC2			Outputs low			0.02	0.5	mA	
laa.	Owner has a summer of forces M		V _{CC1} = 5 V			1.5	3	A	
ICC1	Supply current from V _{CC1}		V _{CC1} = 15 V			1.7	4	mA	

[‡] All typical characteristics are at T_A = 25°C.

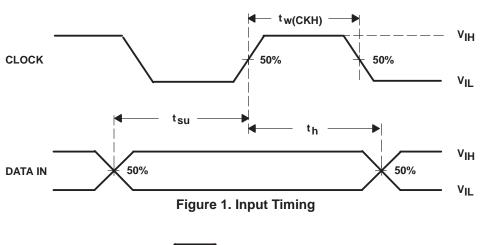
timing requirements over operating free-air temperature range

			MIN	MAX	UNIT
	B.L. J. J. GLOOKI'I	V _{CC1} = 5 V	500		
tw(CKH)	Pulse duration, CLOCK high	V _{CC1} = 15 V	100		ns
	Dulas dematica LATOU ENADI E biob	V _{CC1} = 5 V	500		
tw(LEH)	Pulse duration, LATCH ENABLE high	V _{CC1} = 15 V	100		ns
	Setup time, DATA IN before CLOCK↑	V _{CC1} = 5 V	150		
^t su(D)		V _{CC1} = 15 V	75		ns
	Hald time DATA IN after OLOCKT	V _{CC1} = 5 V	150		
^t h(D)	Hold time, DATA IN after CLOCK↑	V _{CC1} = 15 V	75		ns
^t d(CKH-LEH)	Delay time, CLOCK↑ to LATCH ENABLE high	V _{CC1} = 5 V	150		no
		V _{CC1} = 15 V	75		ns

switching characteristics, V_{BB} = 60 V, T_A = 25°C

	PARAMETER			TYP	MAX	UNIT
	Burnandian delegation I ATOU FNADI F to O code of	V _{CC1} = 5 V		2.2		_
^t pd	t _{pd} Propagation delay time, LATCH ENABLE to Q outputs	V _{CC1} = 15 V		0.8		μS

PARAMETER MEASUREMENT INFORMATION



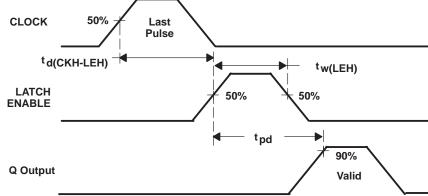


Figure 2. Output Switching Times

THERMAL INFORMATION

DUTY CYCLE FREE-AIR TEMPERATURE 100 N = 1-6 90 80 Maximum Duty Cycle - % 70 60 50 13 14 15 16 17 18 N = 20 40 N = Number of Outputs High and 30 Conducting $I_{OH} = -25$ mA All Other Outputs Low, I_{OL} = 1 mA 20 V_{CC1} = 15 V 10 V_{CC2} = 60 V 0 30 20 60 70 80 90 100 T_A - Free-Air Temperature - $^{\circ}C$

Figure 3

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